

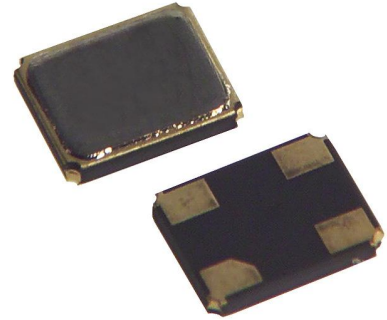
Series TX3

SEAM SEALED CERAMIC 3.2 X 2.5mm SMD



FEATURE

- Ultra thin, thickness 1.0mm
- Leadless type
- High precision characteristic covering up to high frequency range
- Designed for automatic mounting and reflow soldering
- Emboss tapping specification
- The best choice of Bluetooth wireooth wireless communication sets.DSN,PDA and mobile phone.



ELECTRICAL SPECIFICATIONS

Output Frequency Range	12.000 MHz to 48.000 MHz
Mode	see Table 1*
Frequency Tolerance (at 25°C)	±10ppm,±30ppm or specify
Frequency Stability Over Operating Temperature Characteristics	±10ppm,±30ppm or specify
Operating Temperature Range	-10 °C to +60 °C -20 °C to +70 °C -40 °C to +85 °C
Storage Temperature Range	-55 °C to + 125 °C
Shunt Capacitance (C ₀)	5.0 pF Max
Driver Level (Typical)	10μW~100μW
Load Capacitance(C _L)	Series, 16pF, 20pF, 30pF, 32pF, or specify
Aging @25°C 1 st year (Max)	±3ppm/year
Shock Resistance	Drop test of 3 times on 2mm stainless plate from 75cm height

REMARK: SPECIFICATIONS SUBJECT TO CHANGE WITHOUT PRIOR NOTICE. PLEASE CONFIRM WITH OUR SALES ENGINEER.

EQUIVALENT SERIES RESISTANCE (ESR) (Table 1)

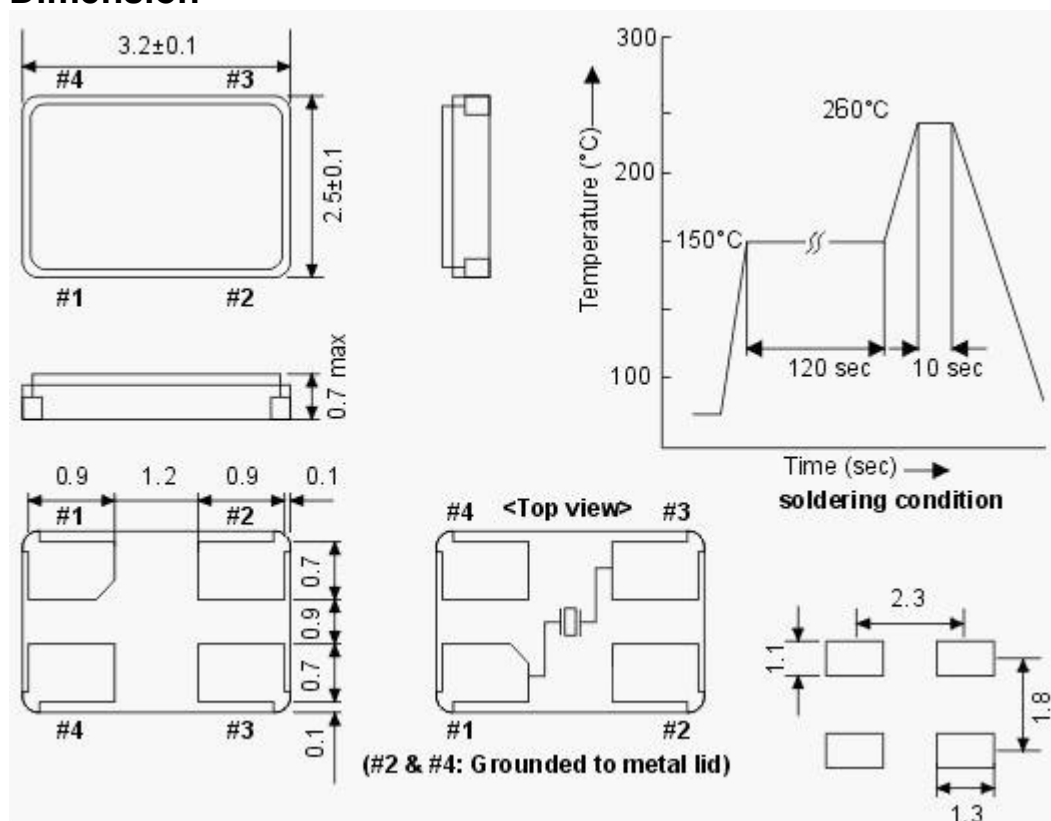
Frequency Range	E.S.R(Ω)	Mode
12~24MHz	80 Ω Max	AT/Fundamental
24~50MHz	60 Ω Max	AT/Fundamental

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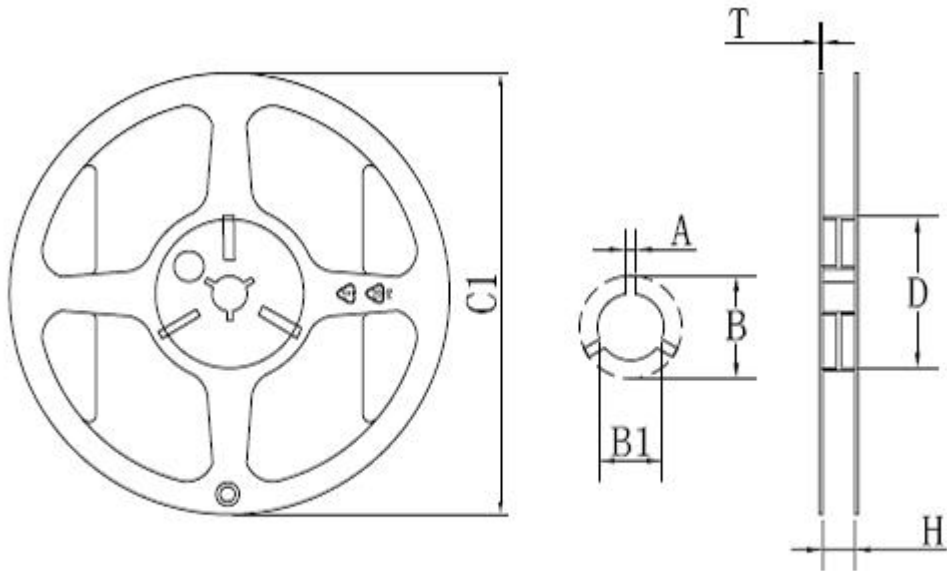
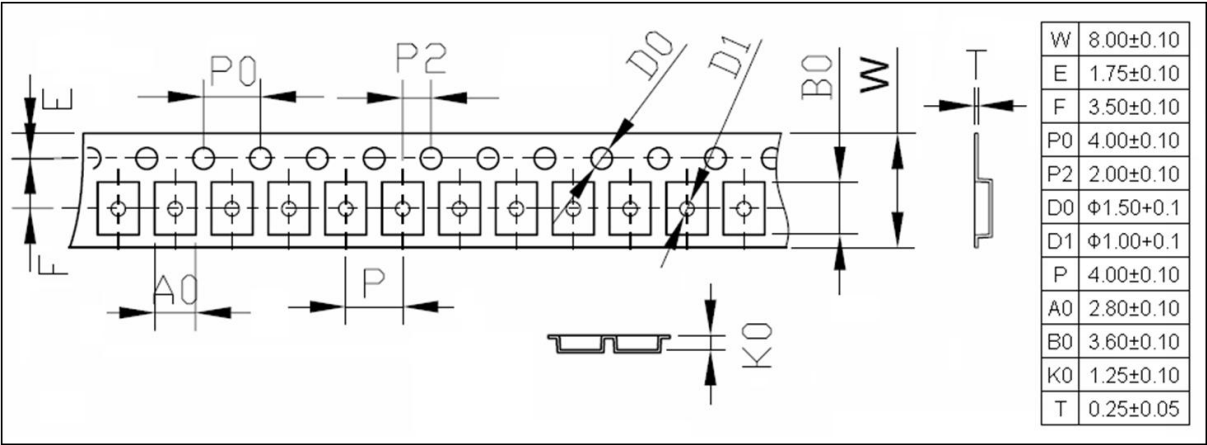
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Dimension



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Tape & Reel



C1±1	A±0.3	B±0.3	B1±0.3	T±0.2	D±0.5	H _{0.5} ^{+0.5}
178	2.5	21.0	13.2	1.0	60.5	8.5